

Features

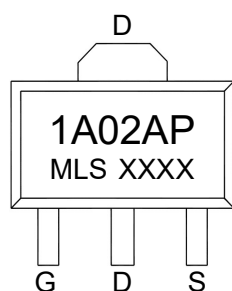
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available
- Advanced high cell density Trench technology

Application

- Video monitor
- Power management

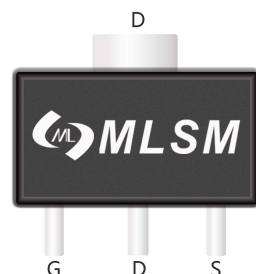
Product Summary

V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
-100V	650mΩ@-10V	-2A
	700mΩ@-4.5V	

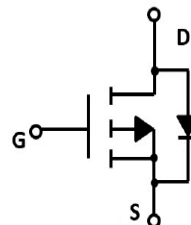


1A02AP : Device code
 XXXX : Code

Marking and pin assignment



SOT-89-3L top view



Schematic diagram



Pb-Free



RoHS



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-100	V
V_{GS}	Gate-Source Voltage	±20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	$T_C=25^{\circ}C$	-2
			A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	$T_C=25^{\circ}C$	-8	A
I_D	Continuous Drain Current	$T_C=25^{\circ}C$	-2	A
P_D	Maximum Power Dissipation	$T_C=25^{\circ}C$	2	W
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient		85	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MZ1A02AP	SOT-89-3L	1A02AP	1,000	10,000	40,000	7"reel

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
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Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)

BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-100	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-100V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-2.0	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-1A	--	560	650	mΩ
		V _{GS} =-4.5V, I _D =-0.5A	--	630	700	mΩ

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)

C _{ISS}	Input Capacitance	V _{DS} =-15V, V _{GS} =0V, f=1MHz	--	553	--	pF
C _{OSS}	Output Capacitance		--	29	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	20	--	pF

Switching Characteristics

Q _g	Total Gate Charge	V _{DS} =-15V, I _D =-2A, V _{GS} =-4.5V	--	4.5	--	nC
Q _{gs}	Gate Source Charge		--	1.15	--	nC
Q _{gd}	Gate Drain Charge		--	1.5	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-50V, I _D =-2A, V _{GS} =-10V, R _G =3.3Ω	--	13.6	--	nS
t _r	Turn-on Rise Time		--	6.8	--	nS
t _{d(off)}	Turn-Off Delay Time		--	34	--	nS
t _f	Turn-Off Fall Time		--	3	--	nS

Source- Drain Diode Characteristics

V _{SD}	Forward on voltage	T _J =25°C, I _S =-2A	--	--	-1.2	V
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Typical Operating Characteristics

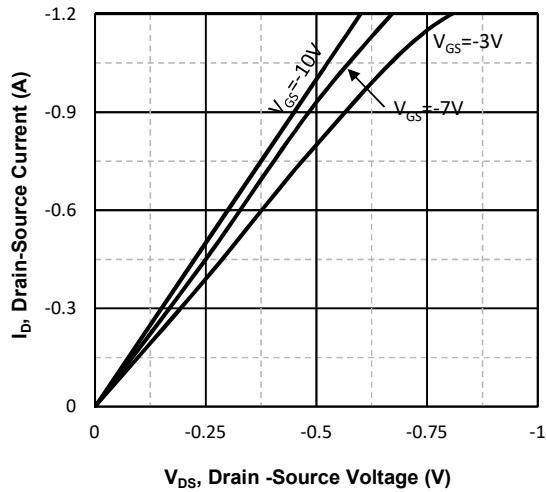


Fig1. Typical Output Characteristics

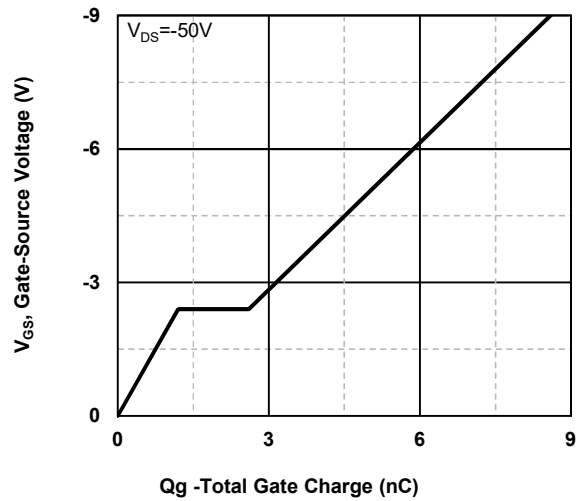


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

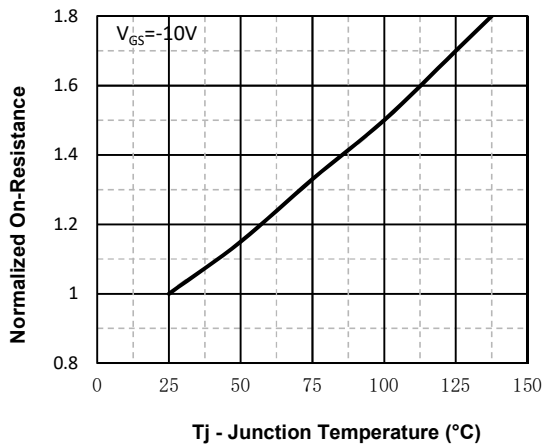


Fig3. Normalized On-Resistance Vs. Temperature

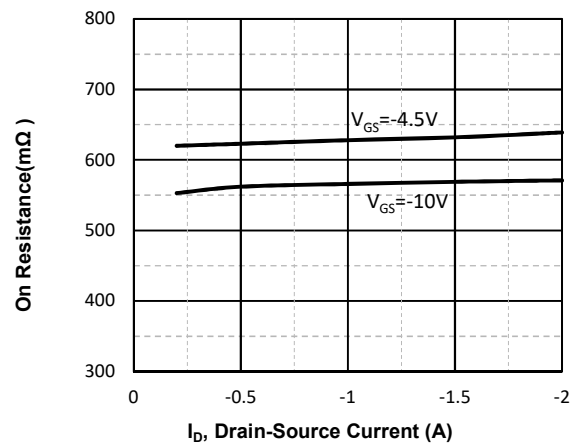


Fig4. On Resistance Vs. Drain-Source Current

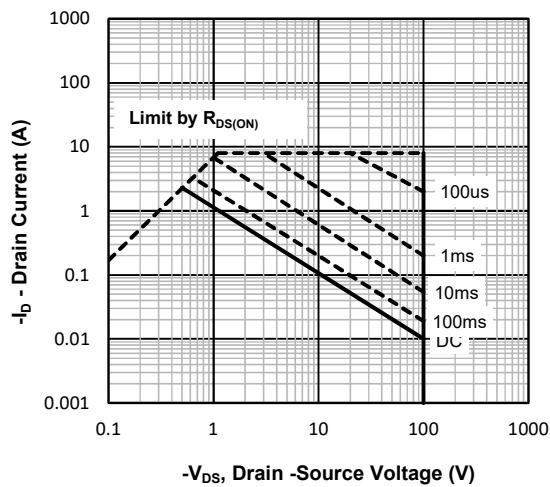


Fig5. Maximum Safe Operating Area

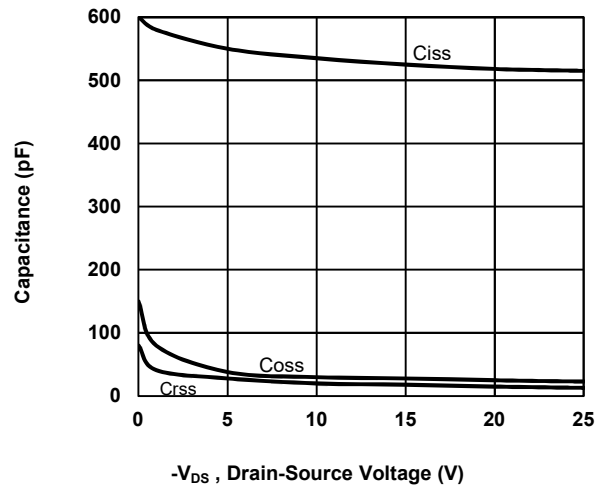
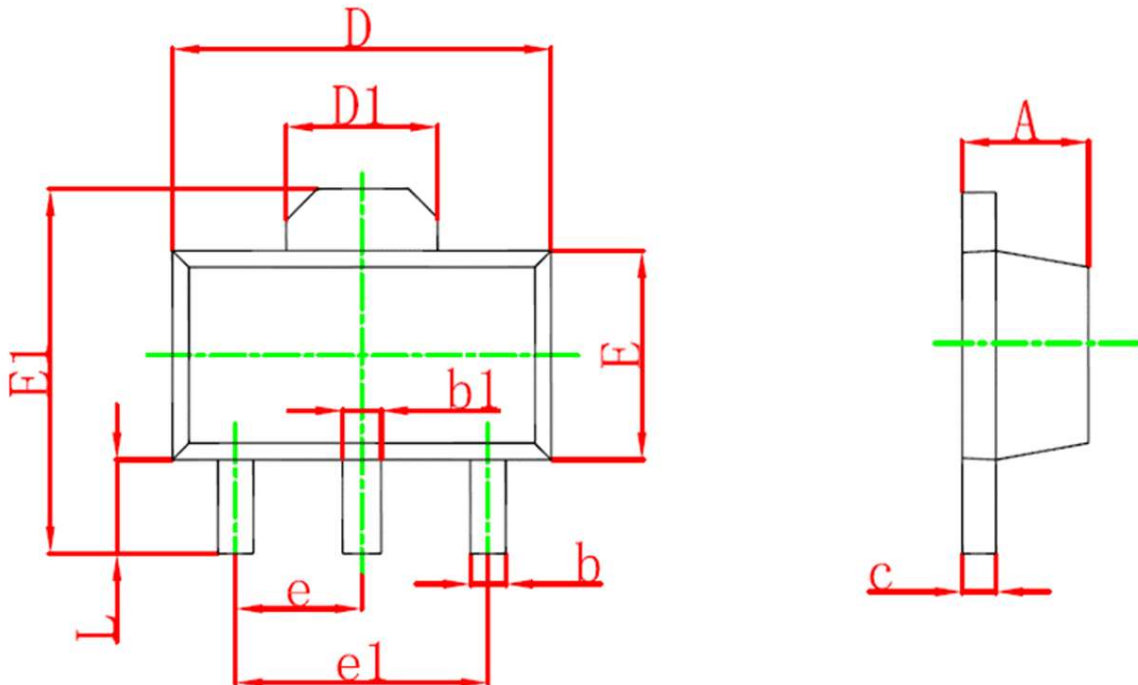


Fig6 Typical Capacitance Vs. Drain-Source Voltage

SOT-89-3L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions in Inches	
	Min	Max	Min	Max
A	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF		0.061 REF	
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP		0.060 TYP	
e1	3.000 TYP		0.118 TYP	
L	0.900	1.200	0.035	0.047